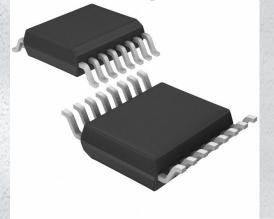


MC74HC165ADTR2 Datasheet

www.digi-electronics.com



DiGi Electronics Part Number	MC74HC165ADTR2-DG
Manufacturer	onsemi
Manufacturer Product Number	MC74HC165ADTR2
Description	IC SHIFT REGISTER 8BIT 16-TSSOP
Detailed Description	Shift Shift Register 1 Element 8 Bit 16-TSSOP

https://www.DiGi-Electronics.com



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RFQ Email: Info@DiGi-Electronics.com

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Purchase and inquiry

Manufacturer:
onsemi
Product Status:
Obsolete
Output Type:
Complementary
Number of Bits per Element:
8
Voltage - Supply:
2V ~ 6V
Mounting Type:
Surface Mount
Supplier Device Package:
16-TSSOP

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
RoHS non-compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.39.0001	

onsemi

8-Bit Serial or Parallel-Input/ Serial-Output Shift Register

High–Performance Silicon–Gate CMOS

MC74HC165A, MC74HCT165A

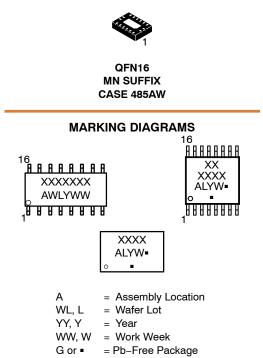
The MC74HC165A/MC74HCT165A is identical in pinout to the LS165. The MC74HC165A inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs. The MC74HCT165A may be used as a level converter for interfacing TTL or NMOS outputs to High–Speed CMOS inputs.

This device is an 8-bit shift register with complementary outputs from the last stage. Data may be loaded into the register either in parallel or in serial form. When the SERIAL SHIFT/PARALLEL LOAD input is low, the data is loaded asynchronously in parallel. When the SERIAL SHIFT/PARALLEL LOAD input is high, the data is loaded serially on the rising edge of either Clock or Clock Inhibit (see the Function Table).

The 2-input NOR clock may be used either by combining two independent clock sources or by designating one of the clock inputs to act as a clock inhibit.

Features

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V (HC), 4.5 to 5.5 V (HCT)
- Low Input Current: 1 μA
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7 A
- Chip Complexity: 286 FETs or 71.5 Equivalent Gates
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant



SOIC-16

D SUFFIX

CASE 751B

(Note: Microdot may be in either location)

ORDERING INFORMATION

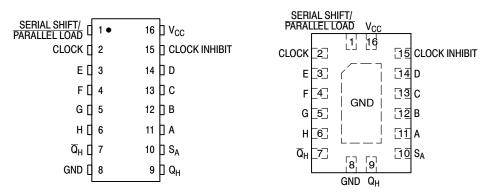
See detailed ordering and shipping information on page 11 of this data sheet.

1

TSSOP-16

DT SUFFIX

CASE 948F





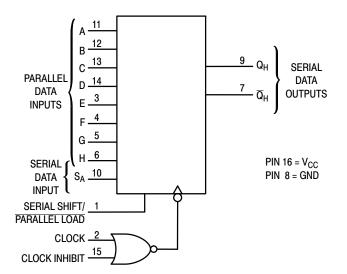


Figure 2. Logic Diagram

FUNCTION	TABLE
----------	-------

	Ir	puts			Internal Stages Output			
Serial Shift/ Parallel Load	Clock	Clock Inhibit	SA	A – H	Q _A	Q _B	Q _H	Operation
L	Х	Х	Х	a h	а	b	h	Asynchronous Parallel Load
H H	ے ح	L L	L H	X X	L H	Q _{An} Q _{An}	Q _{Gn} Q _{Gn}	Serial Shift via Clock
H H	L L	ے ر	L H	X X	L H	Q _{An} Q _{An}	Q _{Gn} Q _{Gn}	Serial Shift via Clock Inhibit
H H	X H	H X	X X	X X	No Change			Inhibited Clock
Н	L	L	Х	Х		No Change		No Clock

X = don't care $Q_{An} - Q_{Gn}$ = Data shifted from the preceding stage

MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage		–0.5 to +6.5	V
V _{IN}	DC Input Voltage		–0.5 to V _{CC} + 0.5	V
V _{OUT}	DC Output Voltage		–0.5 to V _{CC} + 0.5	V
I _{IN}	DC Input Current, per Pin		±20	mA
I _{OUT}	DC Output Current, per Pin		±25	mA
I _{CC}	DC Supply Current, V _{CC} and GND Pins		±50	mA
I _{IK}	Input Clamp Current (V _{IN} < 0 or V _{IN} > V _{CC})		±20	mA
I _{OK}	Output Clamp Current (V _{OUT} < 0 or V _{OUT} > V _{CC})		±20	mA
T _{STG}	Storage Temperature		–65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seconds		260	°C
ΤJ	Junction Temperature Under Bias		±150	°C
θ_{JA}	Thermal Resistance (Note 1)	SOIC-16 QFN16 TSSOP-16	126 118 159	°C/W
P _D	Power Dissipation in Still Air at 25°C	SOIC-16 QFN16 TSSOP-16	995 1062 787	mW
MSL	Moisture Sensitivity		Level 1	-
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V_{ESD}	ESD Withstand Voltage (Note 2)	Human Body Model Charged Device Model	2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.

2. HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Max	Unit
MC74HC					
V _{CC}	DC Supply Voltage		2.0	6.0	V
$V_{IN,} V_{OUT}$	DC Input, Output Voltage (Note 3)		0	V _{CC}	V
T _A	Operating Free-Air Temperature		-55	+125	°C
t _r , t _f	· · · · · · · · · · · · · · · · · · ·	$V_{CC} = 2.0 V$ $V_{CC} = 3.0 V$ $V_{CC} = 4.5 V$ $V_{CC} = 6.0 V$	0 0 0 0	1000 600 500 400	ns

MC74HCT

V _{CC}	DC Supply Voltage	4.5	5.5	V
$V_{\text{IN},}V_{\text{OUT}}$	DC Input, Output Voltage (Note 3)	0	V _{CC}	V
T _A	Operating Free-Air Temperature	-55	+125	°C
t _r , t _f	Input Rise or Fall Time	0	500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

3. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS (MC74HC165A)

		Test Conditions	Vcc	Guaranteed Limit			
Symbol	Parameter		v	–55 to 25°C	≤ 85°C	≤125°C	Unit
V _{IH}	Minimum High–Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\ \left I_{out}\right \leq 20 \; \mu \text{A} \end{array}$	2.0 3.0 4.5 6.0	1.5 2.1 3.15 4.2	1.5 2.1 3.15 4.2	1.5 2.1 3.15 4.2	V
V _{IL}	Maximum Low-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\ \left I_{out} \right \leq 20 \; \mu \text{A} \end{array}$	2.0 3.0 4.5 6.0	0.5 0.9 1.35 1.80	0.5 0.9 1.35 1.80	0.5 0.9 1.35 1.80	V
V _{OH}	Minimum High-Level Output Voltage	$ \begin{aligned} V_{in} &= V_{IH} \text{ or } V_{IL} \\ \left I_{out} \right &\leq 20 \ \mu A \end{aligned} $	2.0 4.5 6.0	1.9 4.4 5.9	1.9 4.4 5.9	1.9 4.4 5.9	V
		$\begin{array}{ll} V_{in} = V_{IH} \text{ or } V_{IL} & \begin{array}{l} I_{out} \leq 2.4 \text{ mA} \\ I_{out} \leq 4.0 \text{ mA} \\ I_{out} \leq 5.2 \text{ mA} \end{array}$	3.0 4.5 6.0	2.48 3.98 5.48	2.34 3.84 5.34	2.20 3.70 5.20	V
V _{OL}	Maximum Low-Level Output Voltage	$ \begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\ \left I_{out} \right \ \leq \ 20 \ \mu A \end{array} $	2.0 4.5 6.0	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V
		$\begin{array}{l l} V_{in} = V_{IH} \text{ or } V_{IL} & \begin{array}{l} I_{out} \leq 2.4 \text{ mA} \\ I_{out} \leq 4.0 \text{ mA} \\ I_{out} \leq 5.2 \text{ mA} \end{array}$	3.0 4.5 6.0	0.26 0.26 0.26	0.33 0.33 0.33	0.40 0.40 0.40	
I _{in}	Maximum Input Leakage Cur- rent	V _{in} = V _{CC} or GND	6.0	± 0.1	±1.0	± 1.0	μA
I _{CC}	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0 \ \mu A$	6.0	4	40	160	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS (MC74HC165A)

		v _{cc}	Guaranteed Limit				
Symbol	Parameter		–55 to 25°C	≤ 85°C	≤125°C	Unit	
f _{max}	Maximum Clock Frequency (50% Duty Cycle) (Figures 3 and 4)	2.0 3.0 4.5 6.0	6 18 30 35	4.8 17 24 28	4 15 20 24	MHz	
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Clock (or Clock Inhibit) to ${\rm Q}_{\rm H}$ or $\overline{\rm Q}_{\rm H}$ (Figures 3 and 4)	2.0 3.0 4.5 6.0	150 52 30 26	190 63 38 33	225 65 45 38	ns	
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Serial Shift/Parallel Load to ${\rm Q}_{\rm H}$ or $\overline{\rm Q}_{\rm H}$ (Figures 3 and 5)	2.0 3.0 4.5 6.0	175 58 35 30	220 70 44 37	265 72 53 45	ns	
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Input H to Q _H or Q _H (Figures 3 and 6)	2.0 3.0 4.5 6.0	150 52 30 26	190 63 38 33	225 65 45 38	ns	
t _{TLH} , t _{THL}	Maximum Output Transition Time, Any Output (Figures 3 and 4)	2.0 3.0 4.5 6.0	75 27 15 13	95 32 19 16	110 36 22 19	ns	
C _{in}	Maximum Input Capacitance	-	10	10	10	pF	

		Typical @ 25°C, V _{CC} = 5.0 V	
C _{PD}	Power Dissipation Capacitance (Per Package)*	40	pF

*Used to determine the no–load dynamic power consumption: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.

TIMING REQUIREMENTS (MC74HC165A)

		Vcc	Guar	anteed Lim	it	
Symbol	Parameter	v	–55 to 25°C	≤ 85°C	≤125°C	Unit
t _{su}	Minimum Setup Time, Parallel Data Inputs to Serial Shift/Parallel Load (Figure 7)	2.0 3.0 4.5 6.0	75 30 15 13	95 40 19 16	110 55 22 19	ns
t _{su}	Minimum Setup Time, Input S _A to Clock (or Clock Inhibit) (Figure 8)	2.0 3.0 4.5 6.0	75 30 15 13	95 40 19 16	110 55 22 19	ns
t _{su}	Minimum Setup Time, Serial Shift/Parallel Load to Clock (or Clock Inhibit) (Figure 9)	2.0 3.0 4.5 6.0	75 30 15 13	95 40 19 16	110 55 22 19	ns
t _{su}	Minimum Setup Time, Clock to Clock Inhibit (Figure 10)	2.0 3.0 4.5 6.0	75 30 15 13	95 40 19 16	110 55 22 19	ns
t _h	Minimum Hold Time, Serial Shift/Parallel Load to Parallel Data Inputs (Figure 7)	2.0 3.0 4.5 6.0	5 5 5 5	5 5 5 5	5 5 5 5	ns
t _h	Minimum Hold Time, Clock (or Clock Inhibit) to Input S _A (Figure 8)	2.0 3.0 4.5 6.0	5 5 5 5	5 5 5 5	5 5 5 5	ns
t _h	Minimum Hold Time, Clock (or Clock Inhibit) to Serial Shift/Parallel Load (Figure 9)	2.0 3.0 4.5 6.0	5 5 5 5	5 5 5 5	5 5 5 5	ns
t _{rec}	Minimum Recovery Time, Clock to Clock Inhibit (Figure 10)	2.0 3.0 4.5 6.0	75 30 15 13	95 40 19 16	110 55 22 19	ns
t _w	Minimum Pulse Width, Clock (or Clock Inhibit) (Figure 4)	2.0 3.0 4.5 6.0	70 27 15 13	90 32 19 16	100 36 22 19	ns
t _w	Minimum Pulse width, Serial Shift/Parallel Load (Figure 5)	2.0 3.0 4.5 6.0	70 27 15 13	90 32 19 16	100 36 22 19	ns
t _r , t _f	Maximum Input Rise and Fall Times (Figure 4)	2.0 3.0 4.5 6.0	1000 800 500 400	1000 800 500 400	1000 800 500 400	ns

MC74HC165ADTR2 onsemi IC SHIFT REGISTER 8BIT 16-TSSOP

MC74HC165A, MC74HCT165A

DC ELECTRICAL CHARACTERISTICS (MC74HCT165A)

				Gu	mit		
Symbol	Parameter	Test Conditions	v _{cc} v	–55 to 25°C	≤85°C	≤125°C	Unit
V _{IH}	Minimum High-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \; V \; or \; V_{CC} - 0.1 \; V \\ \left I_{out}\right \leq 20 \; \mu A \end{array}$	4.5 5.5	2.0 2.0	2.0 2.0	2.0 2.0	V
V _{IL}	Maximum Low-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \; V \; or \; V_{CC} - 0.1 \; V \\ \left I_{out}\right \leq 20 \; \mu A \end{array}$	4.5 5.5	0.8 0.8	0.8 0.8	0.8 0.8	V
V _{OH}	Minimum High-Level Output Voltage		4.5 5.5	4.4 5.4	4.4 5.4	4.4 5.4	V
		$V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \le 4.0 \text{ mA}$	4.5	3.98	3.84	3.7	
V _{OL}	Maximum Low-Level Output Voltage		4.5 5.5	0.1 0.1	0.1 0.1	0.1 0.1	V
		$V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \le 4.0 \text{ mA}$	4.5	0.26	0.33	0.4	
l _{in}	Maximum Input Leakage Current	V _{in} = V _{CC} or GND	5.5	±0.1	±1.0	±1.0	μΑ
I _{CC}	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0 \ \mu A$	5.5	4.0	40	160	μΑ

ΔI_{CC}	Additional Quiescent Supply Current	V_{in} = 2.4 V, Any One Input V_{in} = V _{CC} or GND, Other Inputs		≥ -55°C	25°C to 125°C	
		$I_{out} = 0 \mu A$	5.5	2.9	2.4	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS (MC74HCT165A)

	Parameter		Guaranteed Limit			
Symbol			–55 to 25°C	≤ 85°C	≤125°C	Unit
f _{max}	Maximum Clock Frequency (50% Duty Cycle) (Figures 3 and 4)	4.5 5.5	30 35	24 28	20 24	MHz
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Clock (or Clock Inhibit) to ${\rm Q}_{\rm H}$ or $\overline{\rm Q}_{\rm H}$ (Figures 3 and 4)	4.5 5.5	30 26	38 33	45 38	ns
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Serial Shift/Parallel Load to ${\rm Q}_{\rm H}$ or $\overline{\rm Q}_{\rm H}$ (Figures 3 and 5)	4.5 5.5	35 30	44 37	53 45	ns
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Input H to Q_H or \overline{Q}_H (Figures 3 and 6)	4.5 5.5	30 26	38 33	45 38	ns
t _{TLH} , t _{THL}	Maximum Output Transition Time, Any Output (Figures 3 and 4)	4.5 5.5	15 13	19 16	22 19	ns
C _{in}	Maximum Input Capacitance	-	10	10	10	pF

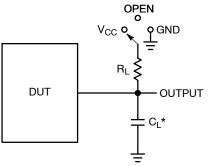
		Typical @ 25°C, V _{CC} = 5.0 V	
C _{PD}	Power Dissipation Capacitance (Per Package)*	40	pF

*Used to determine the no-load dynamic power consumption: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.

TIMING REQUIREMENTS (MC74HCT165A)

		v _{cc}	Guar	anteed Lim	it	
Symbol	Parameter		–55 to 25°C	≤ 85°C	≤ 125°C	Unit
t _{su}	Minimum Setup Time, Parallel Data Inputs to Serial Shift/Parallel Load (Figure 7)	4.5 5.5	15 13	19 16	22 19	ns
t _{su}	Minimum Setup Time, Input S _A to Clock (or Clock Inhibit) (Figure 8)	4.5 5.5	15 13	19 16	22 19	ns
t _{su}	Minimum Setup Time, Serial Shift/Parallel Load to Clock (or Clock Inhibit) (Figure 9)	4.5 5.5	15 13	19 16	22 19	ns
t _{su}	Minimum Setup Time, Clock to Clock Inhibit (Figure 10)	4.5 5.5	15 13	19 16	22 19	ns
t _h	Minimum Hold Time, Serial Shift/Parallel Load to Parallel Data Inputs (Figure 7)	4.5 5.5	5 5	5 5	5 5	ns
t _h	Minimum Hold Time, Clock (or Clock Inhibit) to Input S _A (Figure 8)	4.5 5.5	5 5	5 5	5 5	ns
t _h	Minimum Hold Time, Clock (or Clock Inhibit) to Serial Shift/Parallel Load (Figure 9)	4.5 5.5	5 5	5 5	5 5	ns
t _{rec}	Minimum Recovery Time, Clock to Clock Inhibit (Figure 10)	4.5 5.5	15 13	19 16	22 19	ns
t _w	Minimum Pulse Width, Clock (or Clock Inhibit) (Figure 4)	4.5 5.5	15 13	19 16	22 19	ns
t _w	Minimum Pulse width, Serial Shift/Parallel Load (Figure 5)	4.5 5.5	15 13	19 16	22 19	ns
t _r , t _f	Maximum Input Rise and Fall Times (Figure 4)	4.5 5.5	500 400	500 400	500 400	ns

SWITCHING WAVEFORMS



Test	Switch Position	CL	RL
t _{PLH} / t _{PHL}	Open	50 pF	1 kΩ
t _{PLZ} / t _{PZL}	V _{CC}		
t _{PHZ} / t _{PZH}	GND]	

 $^{*}C_{L}$ Includes probe and jig capacitance



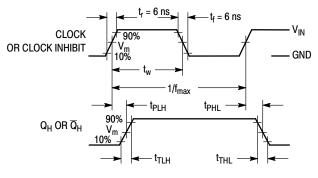


Figure 4. Serial–Shift Mode

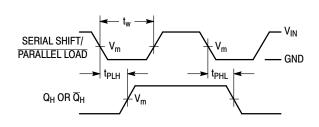
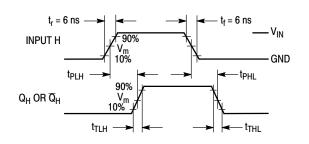
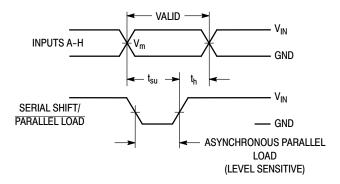


Figure 5. Parallel-Load Mode









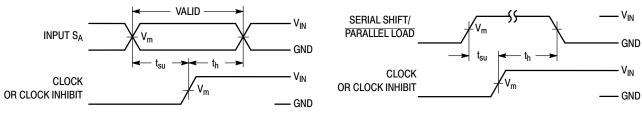




Figure 9. Serial-Shift Mode

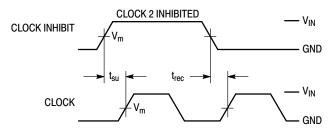


Figure 10. Serial-Shift, Clock-Inhibit Mode

PIN DESCRIPTIONS

INPUTS

A, B, C, D, E, F, G, H (Pins 11, 12, 13, 14, 3, 4, 5, 6)

Parallel Data inputs. Data on these inputs are asynchronously entered in parallel into the internal flip-flops when the Serial Shift/Parallel Load input is low.

SA (Pin 10)

Serial Data input. When the Serial Shift/Parallel Load input is high, data on this pin is serially entered into the first stage of the shift register with the rising edge of the Clock.

CONTROL INPUTS

Serial Shift/Parallel Load (Pin 1)

Data–entry control input. When a high level is applied to this pin, data at the Serial Data input (S_A) are shifted into the register with the rising edge of the Clock. When a low level

is applied to this pin, data at the Parallel Data inputs are asynchronously loaded into each of the eight internal stages.

Clock, Clock Inhibit (Pins 2, 15)

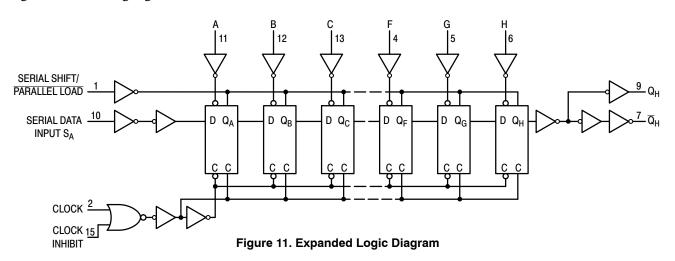
Clock inputs. These two clock inputs function identically. Either may be used as an active-high clock inhibit. However, to avoid double clocking, the inhibit input should go high only while the clock input is high.

The shift register is completely static, allowing Clock rates down to DC in a continuous or intermittent mode.

OUTPUTS

Q_H, \overline{Q}_H (Pins 9, 7)

Complementary Shift Register outputs. These pins are the noninverted and inverted outputs of the eighth stage of the shift register.



MC74HC165ADTR2 onsemi IC SHIFT REGISTER 8BIT 16-TSSOP

MC74HC165A, MC74HCT165A

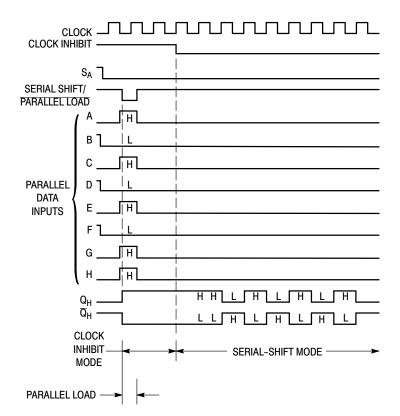


Figure 12. Timing Diagram

ORDERING INFORMATION

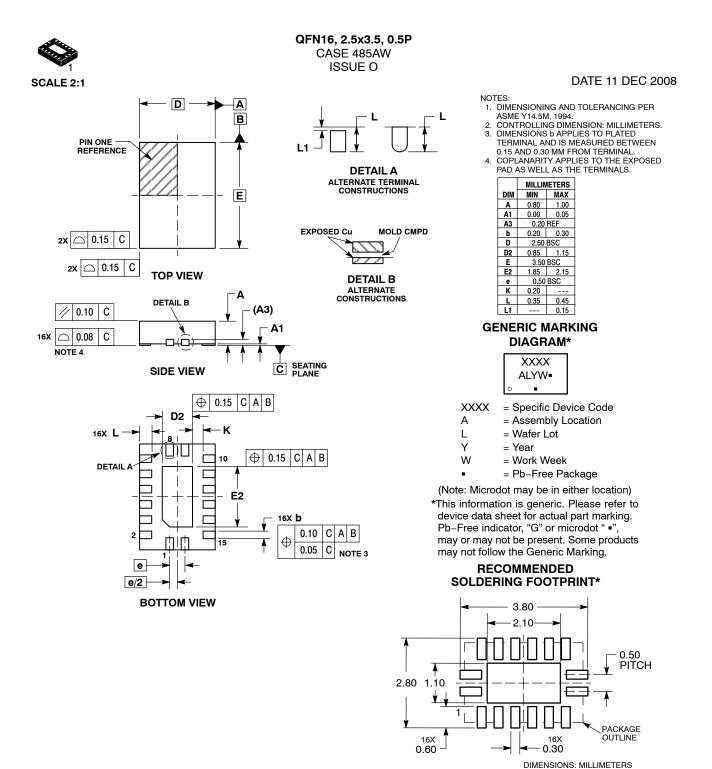
Device	Marking	Package	Shipping [†]
MC74HC165ADG	HC165AG	SOIC-16	48 Units / Rail
MC74HC165ADR2G	HC165AG	SOIC-16	2500 / Tape & Reel
MC74HC165AD2G-Q*	HC165AG	SOIC-16	2500 / Tape & Reel
MC74HC165ADTR2G	HC 165A	TSSOP-16	2500 / Tape & Reel
MC74HC165ADTR2G-Q*	HC 165A	TSSOP-16	2500 / Tape & Reel
MC74HC165AMNTWG	165A	QFN16	3000 / Tape & Reel
MC74HC165AMN2TWG	165A	QFN16	3000 / Tape & Reel
MC74HC165AMN2TWG-Q*	165A	QFN16	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

onsemi

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	QFN16, 2.5X3.5, 0.5P		PAGE 1 OF 1			

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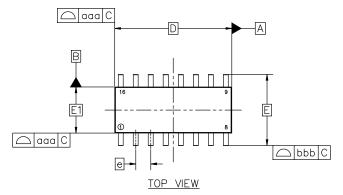


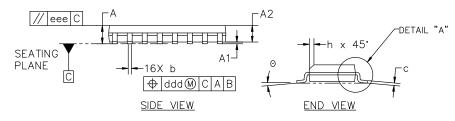
SOIC-16 9.90x3.90x1.37 1.27P CASE 751B ISSUE M

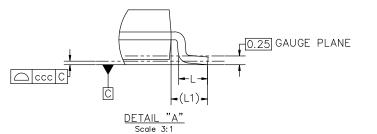
DATE 18 OCT 2024

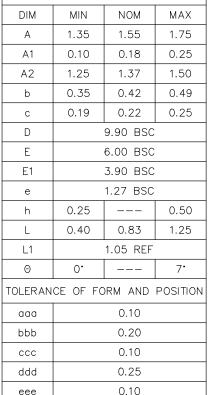
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. DIMENSION IN MILLIMETERS. ANGLE IN DEGREES.
- 3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.15mm PER SIDE.
- DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127mm TOTAL IN EXCESS OF THE & DIMENSION AT MAXIMUM MATERIAL CONDITION.

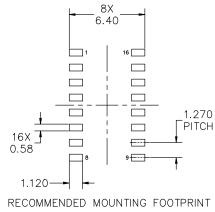








MILLIMETERS



*FOR ADDITIONAL INFORMATION ON OUR *FOR ADDITIONAL INFORMATION ON OUR PB--FRE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE onsemi SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D

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DATE 18 OCT 2024

GENERIC MARKING DIAGRAM*

16	A	H	A.	- A	R	A	A	Æ
		XX)	XX	X	XX	XX	XX	G
		XX	XX)	XX	XX	XX)	XX	x
	0		A١	NĽ	YW	/W		
1	H	Н	Н	Н	Н	H	H	Ъ

XXXXX = Specific Device Code

= Assembly Location

- WL = Wafer Lot
- Y = Year

А

- WW = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:		STYLE 2:		STYLE 3:		TYLE 4:	
PIN 1.	COLLECTOR	PIN 1.	CATHODE	PIN 1.	COLLECTOR, DYE #1	PIN 1.	COLLECTOR, DYE #1
2.		2.	ANODE	2.		2.	
2.	EMITTER	2.	NO CONNECTION	2.	EMITTER, #1	2.	
3. 4.	NO CONNECTION	J. 4.	CATHODE	3. 4.	,	3. 4.	
4. 5.	EMITTER	4. 5.	CATHODE	4. 5.	COLLECTOR, #1	4. 5.	
5. 6.	BASE	5.	NO CONNECTION	5. 6.	BASE, #2	J. 6.	, .
0. 7.	COLLECTOR	0. 7.		0. 7.		0. 7.	
7.	COLLECTOR	7.			COLLECTOR, #2	7. 8.	
•••	BASE	o. 9.	CATHODE		COLLECTOR, #2 COLLECTOR, #3	o. 9.	
	EMITTER	•••	ANODE		BASE. #3		EMITTER. #4
	NO CONNECTION	10.			EMITTER, #3		BASE, #3
	EMITTER		CATHODE		COLLECTOR. #3		EMITTER, #3
	BASE		CATHODE		COLLECTOR, #3		BASE, #2
	COLLECTOR		NO CONNECTION		BASE, #4		EMITTER, #2
	EMITTER		ANODE		EMITTER. #4	14.	
	COLLECTOR	15.	CATHODE		COLLECTOR, #4	16.	- ,
10.	COLLECTOR	10.	CATHODE	10.	COLLECTOR, #4	10.	EIVITTEN, #T
STYLE 5:		STYLE 6:	0.17110055	STYLE 7:			
PIN 1.	DRAIN, DYE #1	PIN 1.	CATHODE	PIN 1.	SOURCE N-CH		
2.	DRAIN, #1	2.	CATHODE	2.			
3.	DRAIN, #2	3.	CATHODE	3.			
4.	DRAIN, #2	4.			GATE P-CH		
5.	DRAIN, #3	5.	CATHODE	5.	COMMON DRAIN (OUTPUT)		
6.	DRAIN, #3	6.	CATHODE	6.			
7.	DRAIN, #4	7.	CATHODE	7.	COMMON DRAIN (OUTPUT)		
8.	DRAIN, #4	8.	CATHODE	8.			
9.	GATE, #4	9.	ANODE	9.	••••		
10.	SOURCE, #4	10.	ANODE	10.			
11.	GATE, #3	11.	ANODE	11.			
12.	SOURCE, #3	12.		12.			
13.	GATE, #2		ANODE		GATE N-CH		
14.	SOURCE, #2		ANODE	14.			
15.	GATE, #1	15.	ANODE	15.	COMMON DRAIN (OUTPUT)		
16.	SOURCE, #1	16.	ANODE	16.	SOURCE N-CH		

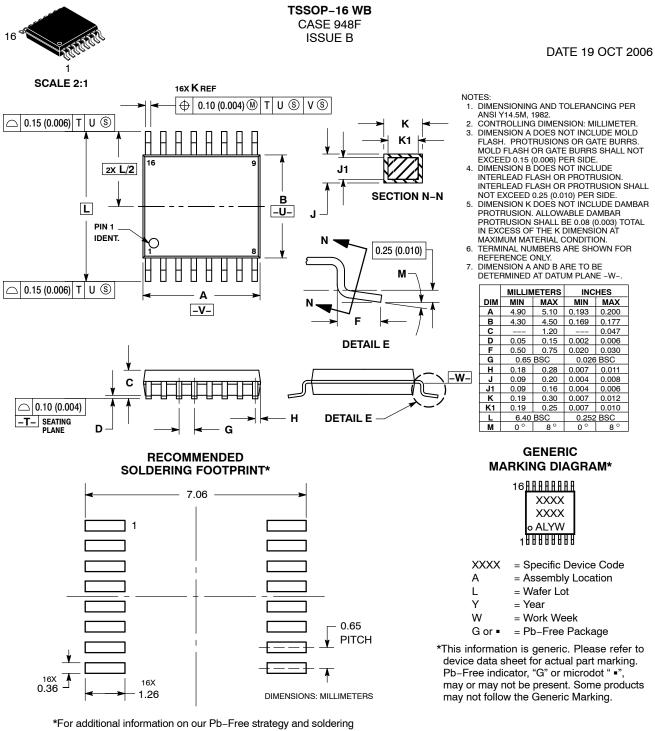
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MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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